

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. No. : **10/534,962** Confirmation No. **1696**  
Applicant(s) : **KONDO, Masayoshi et al.**  
Filed : **May 16, 2005**  
TC/A.U. : **2841**  
Examiner : **Ishwarbhai B.Patel**  
  
Title : **CIRCUIT BOARDS, MULTILAYER WIRING BOARDS, METHOD  
OF PRODUCING CIRCUIT BOARDS, AND METHOD OF  
PRODUCING MULTILAYER WIRING BOARDS**  
  
Docket No. : **033036.088**  
Customer No. : **25461**

**MAIL STOP AMENDMENT**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
Sir:

**AMENDMENT**

In response to the Office Action of September 7, 2007, please amend the application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 10 of this paper.